Applicab	le standard																		
Operating		-35 °C to +85 °C(Note 1)			Storage		-10 °C to +60 °C(Note3)												
	temperature range		-		emperature ra Storage	perature range													
Rating	Operating humidity range				umidity rang	•		40 % to 70 %(Note3)											
	Current				/oltage			150 V AC(DC)											
			Speci	ficatio	ns														
	tem		Test method				Rea	uirements	QT	AT									
Construc		l	rest method				ксч	unementa	G										
General examination		Visually and by measuring instrument.			Accordi	According to drawing.				Х									
Marking		Confirmed visually.								X									
Electric characterist									Х										
Contact resistance		100 mA (DC or 1000 Hz).			30 mΩ	30 mΩ MAX.				-									
Insulation resistance		100 V DC.			500 MΩ	500 MΩ MIN.				-									
Voltage proof		500 V AC for 1 min.			No flas	No flashover or breakdown.				—									
Mechani	cal charact	eristics																	
Mechanical operation		50 times insertions and extractions.			1) Cont	1) Contact resistance: 30 m Ω MAX.													
·					2) No d	2) No damage, crack or looseness of parts.				_									
Vibration		Frequency 10 to 55 Hz, single amplitude			1) No el	1) No electrical discontinuity of 1 μs.													
Shock		0.75 mm, at 2 h, for 3 directions.				2) No damage, crack or looseness of parts.				-									
		490 m/s ² duration of pulse 11 ms at 3 times for 3 directions.																	
Environn	nental char		-						Х	_									
Rapid chan			ature -55 \rightarrow 5 to 35 \rightarrow +85 \rightarrow 5 to	35 °C	1) Cont	act resista	nco	30 mΩ MAX.	1										
temperature		Time $30 \rightarrow 5 \text{ max} \rightarrow 30 \rightarrow 5 \text{ max min}$,	 a) Insulation resistance: 500 MΩ MIN. b) No damage, crack or looseness of parts. 				_									
		Under 5 cycles. Exposed at 40±2 °C, 90 to 95 %, 96 h.			3) No d														
Damp heat																			
(steady state)		1) Dofle	w addarian		No dofe	rmation	of or	an of overerive	Х	-									
Resistance to soldering heat		1) Reflow soldering ≪Reflow area≫ Max250 °C within 10 sec				No deformation of case of excessive looseness of the terminals.				_									
					1000011														
		Min 230 °C within 60 sec																	
		≪Preheating area≫ 170 °C to 190 °C 60 sec to 120 sec put through in reflow fumace twice leave in ambient temperature and humidity for 1 hour.																	
		Connector temperature to be ambient for second reflow. 2) Manual soldering Soldering iron temperature: 350±5 °C,																	
											Soldering time: 5±1 sec. No strength on contact.								
		Solderability		Soldered at solder temperature, 235±5 °C for insertion duration, 3 sec.				Solder shall cover a minimum of 95 % of the surface being immersed.				_							
		Remarks		20010			35 /0 0		ace	being inmersed.	X								
Note 1:Include	e the temperature	e rising by cu	urrent.																
Note 2:No con	0	f long term	storage for unused products before p	ch on board															
		-	perature and humidity range is applied			g transpor	tatior	ì.											
		ied, refer to IEC 60512.																	
Count		Description of revisions Desig			esigned			Checked	Da	ate									
						Approv		HS. OKAWA	-	05.30									
						Checke		TS. FUKUSHIMA)5.30									
						Design		HT. SATO)5.30									
						Drawr	ו	HK. HAYASHI)5.30									
Note QT:C	Qualification Te	st AT:Assurance Test X:Applicable Test			Drawing	Drawing no.		ELC-160525-83-00											
IRS		Specification sheet			art no.	DF14A-25P-1.25H(83)				[
		Hirose electric co., ltd.			ode no.	CL538-0124-7-83			⚠	1/1									

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